



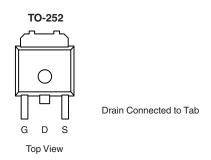
# P-Channel 40 V (D-S), 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>		
- 40	0.0094 at V <sub>GS</sub> = - 10 V	- 50		
	0.0145 at V <sub>GS</sub> = - 4.5 V	- 50		

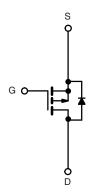
### **FEATURES**

- TrenchFET® Power MOSFETs
- 175 °C Junction Temperature
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: SUD50P04-09L-E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 40	- v	
Gate-Source Voltage		$V_{GS}$	± 20		
Continuous Proin Current /T = 175 °C\	T <sub>C</sub> = 25 °C	l <sub>D</sub>	- 50 <sup>d</sup>	A	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 125 °C		- 50 <sup>d</sup>		
Pulsed Drain Current		I <sub>DM</sub>	- 100	A	
Avalanche Current		I <sub>AS</sub>	- 50	]	
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	125	mJ	
Power Dissipation	T <sub>C</sub> = 25 °C	В	136 <sup>c</sup>	W	
rower Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>b, c</sup>	7	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient <sup>b</sup>	t ≤ 10 s	- R <sub>thJA</sub>	15	18	°C/W
Junction-to-Ambient	Steady State		40	50	
Junction-to-Case		R <sub>thJC</sub>	0.82	1.1	

### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.
- d. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 40			- 3 V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1		- 3		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
	I <sub>DSS</sub>	V <sub>DS</sub> = - 32 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = -32 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50		
		$V_{DS} = -32 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			- 150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 50			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 24 A		0.0075	0.0094		
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 50 A, T <sub>J</sub> = 125 °C			0.014	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 50 A, T <sub>J</sub> = 175 °C			0.017		
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 18 A		0.0115	0.0145		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 24 A		73		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			4800		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 25 V, f = 1 MHz		700			
Reverse Transfer Capacitance	C <sub>rss</sub>	]		550			
Total Gate Charge <sup>c</sup>	Qg			102	150		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 50 A		18.5		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	]		27			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			10	15		
Rise Time <sup>c</sup>		$V_{DD} = -20 \text{ V}, R_1 = 0.4 \Omega$		60	90		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong -50 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 6 \Omega$		145	220	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>	1		140	220		
Source Drain-Diode Ratings and Cha	aracteristics <sup>*</sup>	T <sub>C</sub> = 25 °C <sup>b</sup>					
Continuous Current	I <sub>S</sub>				- 50	۸	
Pulsed Current	I <sub>SM</sub>				- 100	_ A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 50 A, V <sub>GS</sub> = 0 V		- 1.0	- 1.5	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 50 A, dI/dt = 100 A/μs		55	85	ns	

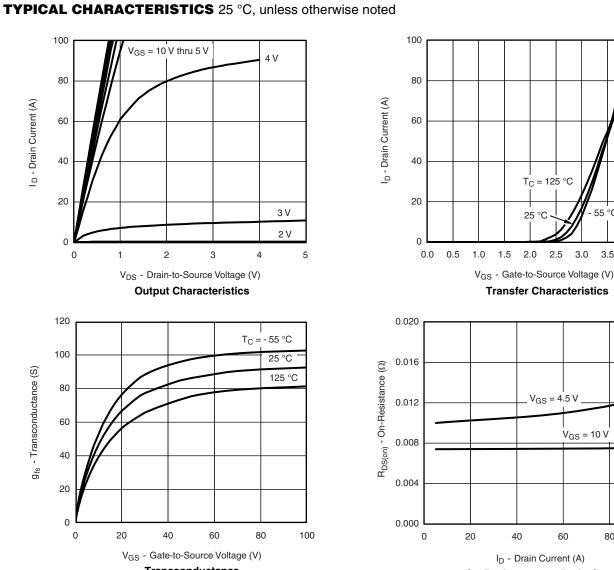
# Notes:

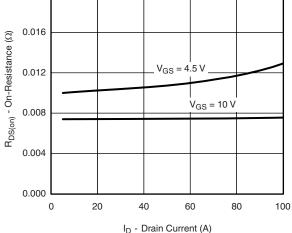
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4.0







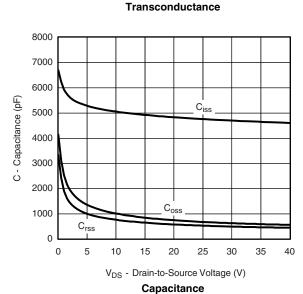
T<sub>C</sub> = 125 °C

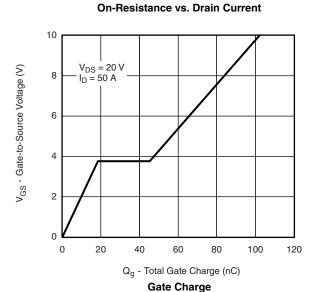
**Transfer Characteristics** 

25 °C

2.0 2.5 3.0 3.5

1.5





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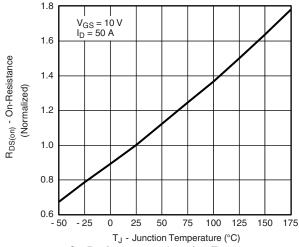
P(t) = 0.0001

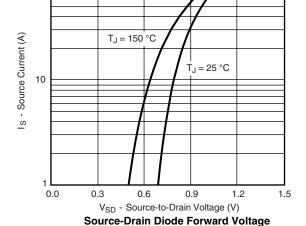
P(t) = 0.001

P(t) = 0.01

+++++**i** P(t) = 0.1

# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

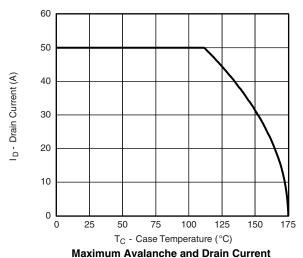


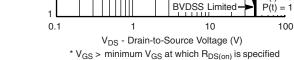


I<sub>DM</sub> Limited

On-Resistance vs. Junction Temperature

## THERMAL RATINGS

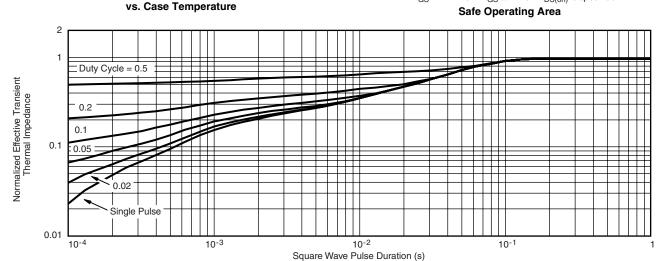




T<sub>C</sub> = 25 °C Single Pulse

Limited by R<sub>DS(on)</sub>

 $I_{D(on)}$ 



1000

100

10

D - Drain Current (A)

#### Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?72243">www.vishay.com/ppg?72243</a>.



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